

1A, 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

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- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.066g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
lf	1	Α			
V_{RRM}	200	V			
I _{FSM}	40	Α			
T _{J MAX}	150	°C			
Package	DO-214AC (SMA)				
Configuration	Single die				









DO-214AC (SMA)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	SS120	UNIT		
Marking code on the device		SS120			
Repetitive peak reverse voltage	V_{RRM}	200	V		
Reverse voltage, total rms value	V _{R(RMS)}	140	V		
Forward current	l _F	1	А		
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	40	А		
Critical rate of rise of off-state voltage	dV/dt	10,000	V/µs		
Junction temperature	TJ	-55 to +150	°C		
Storage temperature	T _{STG}	-55 to +150	°C		



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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	R _Ð JL	28	°C/W	
Junction-to-ambient thermal resistance	Rеja	88	°C/W	
Junction-to-case thermal resistance	Rejc	30	°C/W	

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
5	I _F = 1A, T _J = 25°C	VF	0.82	0.95	V
Forward voltage ⁽¹⁾	I _F = 1A, T _J = 125°C		0.65	0.85	V
December 20 month (2)	T _J = 25°C	I _R	-	100	μΑ
Reverse current @ rated V _R ⁽²⁾	T _J = 125°C		-	2	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE	PACKAGE	PACKING			
SS120	DO-214AC (SMA)	7,500 / Tape & Reel			



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

AVERAGE TORWARD CURRENT (A)

30 60 90 120 150

LEAD TEMPERATURE (C)

Fig.2 Typical Junction Capacitance

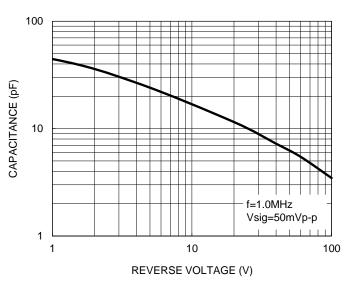


Fig.3 Typical Reverse Characteristics

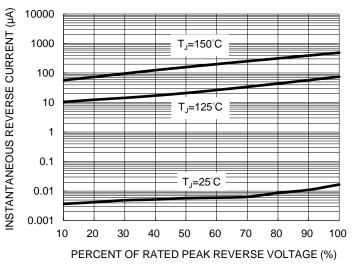
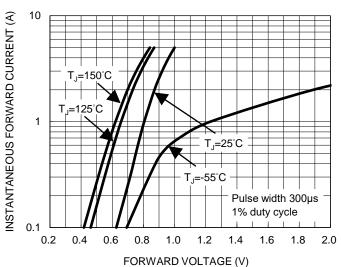


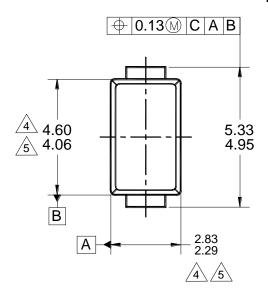
Fig.4 Typical Forward Characteristics

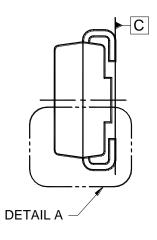


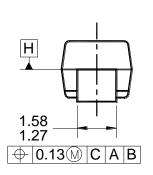


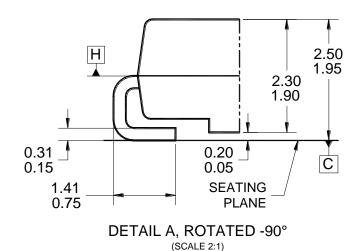
PACKAGE OUTLINE DIMENSIONS

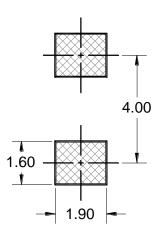
DO-214AC (SMA)



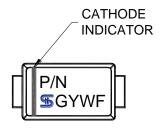








SUGGESTED PAD LAYOUT



MARKING DIAGRAM

P/N = MARKING CODE

G = GREEN COMPOUND

YW = DATE CODE

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AC, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
- 6. DWG NO. REF: HQ2SD07-DO214SMC-034 REV A.



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